



US00D463375S

(12) **United States Design Patent** (10) **Patent No.:** **US D463,375 S**
Nakayama (45) **Date of Patent:** **** Sep. 24, 2002**

(54) **CONNECTOR FOR PRINTED CIRCUIT
BOARDS**

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(**) Term: **14 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (7) Cl.** **13-03**

(52) **U.S. Cl.** **D13/147**

(58) **Field of Search** D13/147; 439/350,
439/352, 353, 354, 358, 489, 752

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(57) **CLAIM**

The ornamental design for a connector for printed circuit
boards, as shown and described.

DESCRIPTION

FIG. 1 is a top plan view thereof;
FIG. 2 is a front elevation thereof;
FIG. 3 is a bottom plan view thereof;
FIG. 4 is a right side elevation thereof;
FIG. 5 is a rear elevation thereof;
FIG. 6 is a cross section thereof taken along the line 6—6 in
FIG. 1; and,
FIG. 7 is a perspective view thereof.

1 Claim, 3 Drawing Sheets

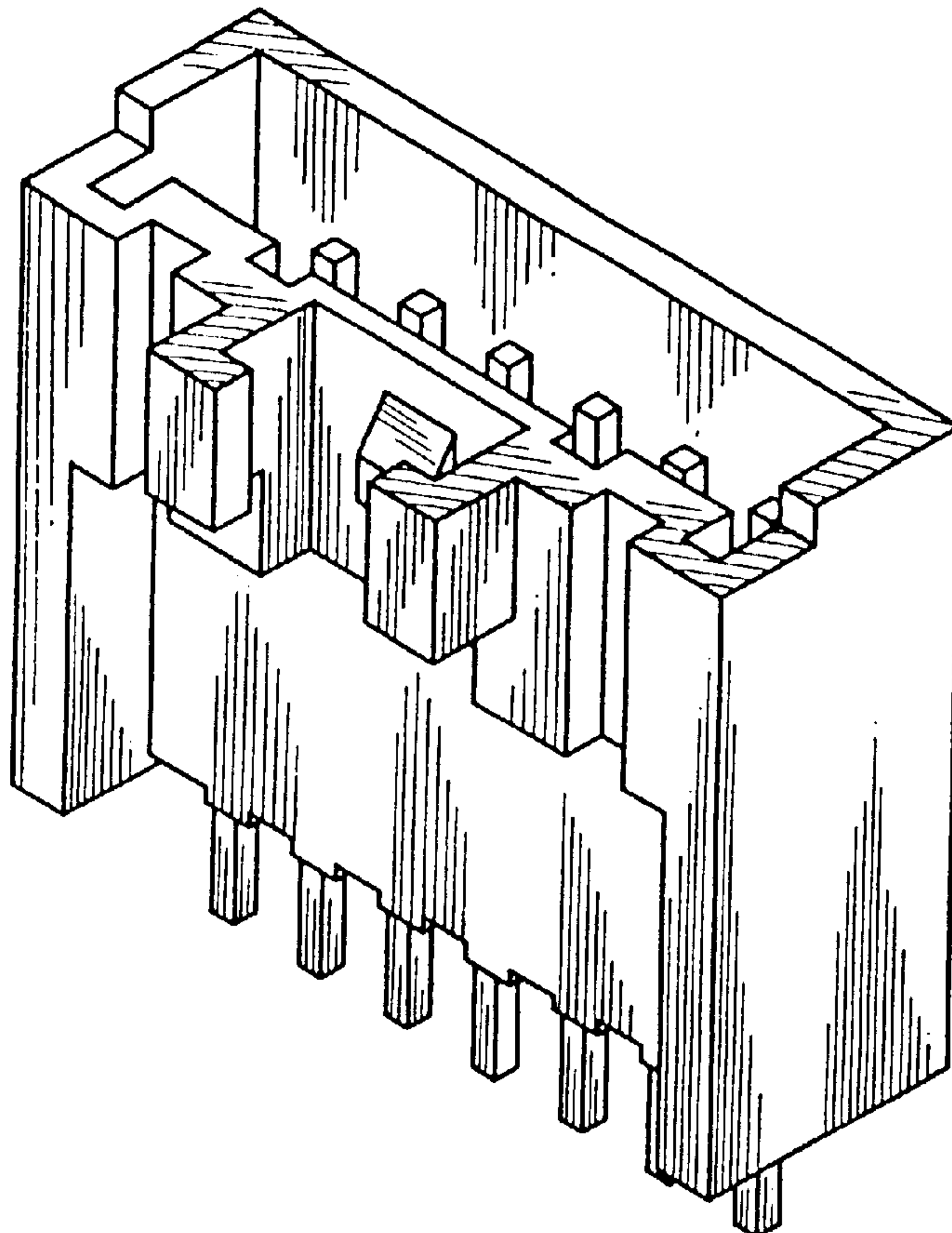


Fig. 1

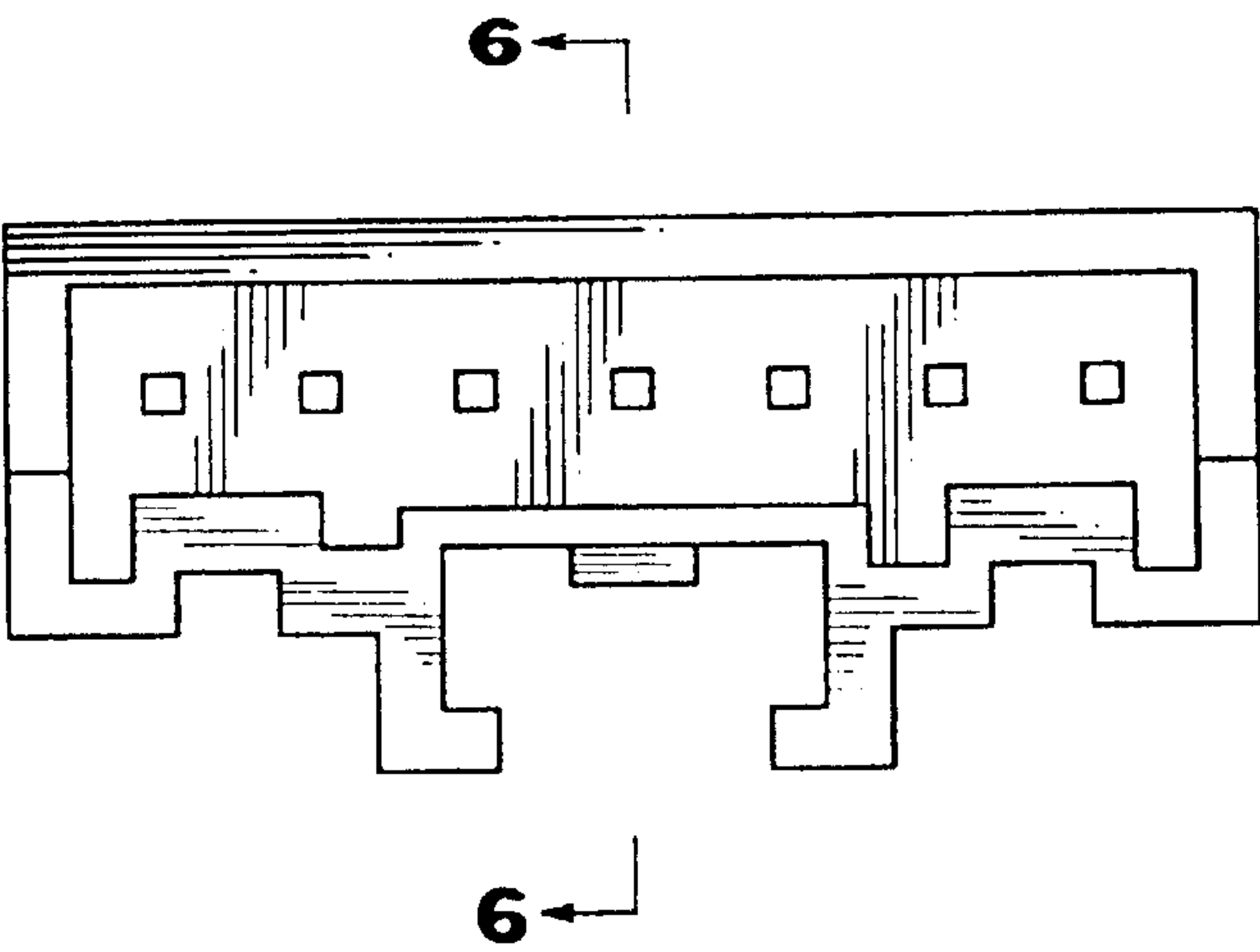


Fig. 2

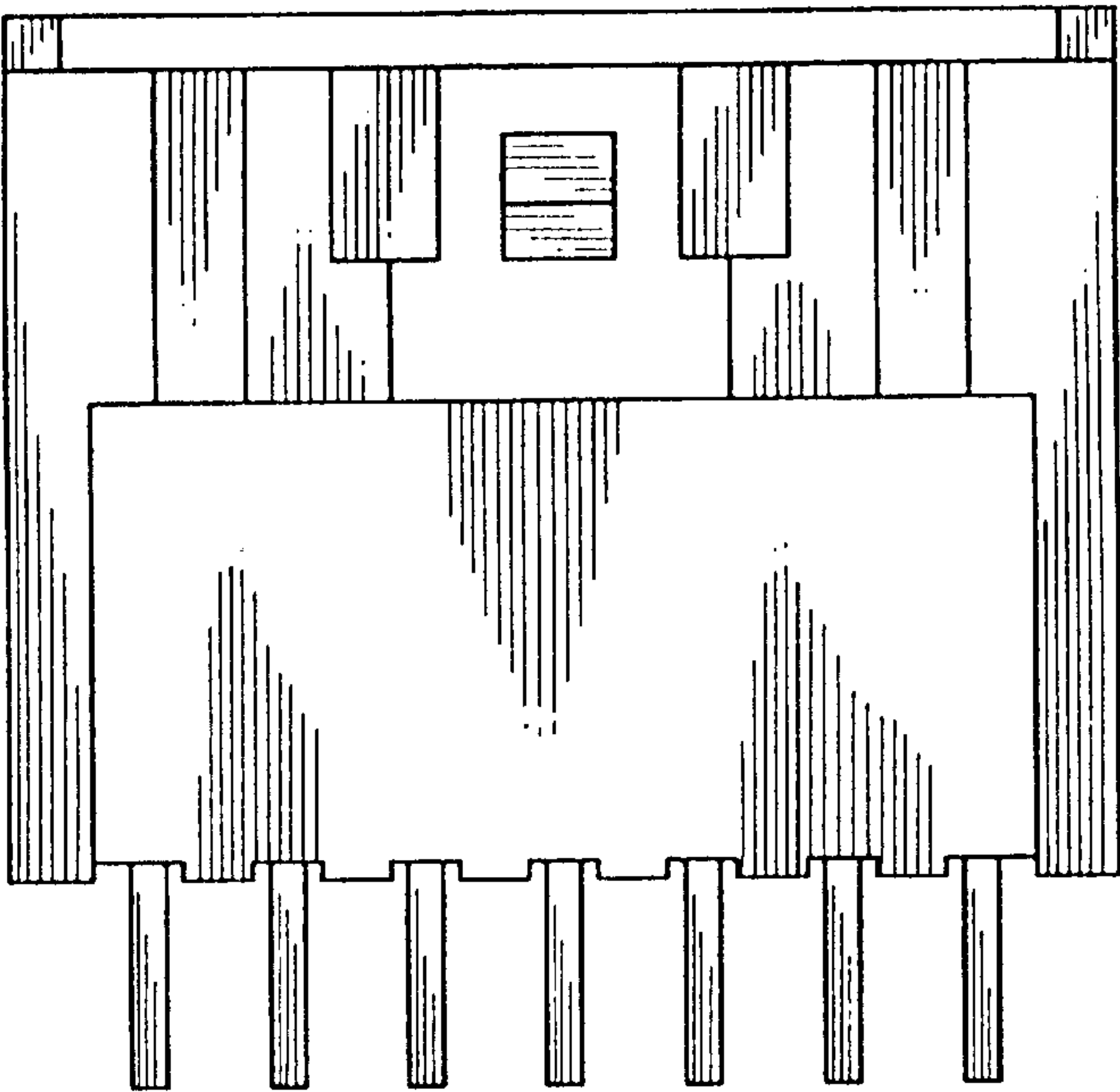


Fig. 3

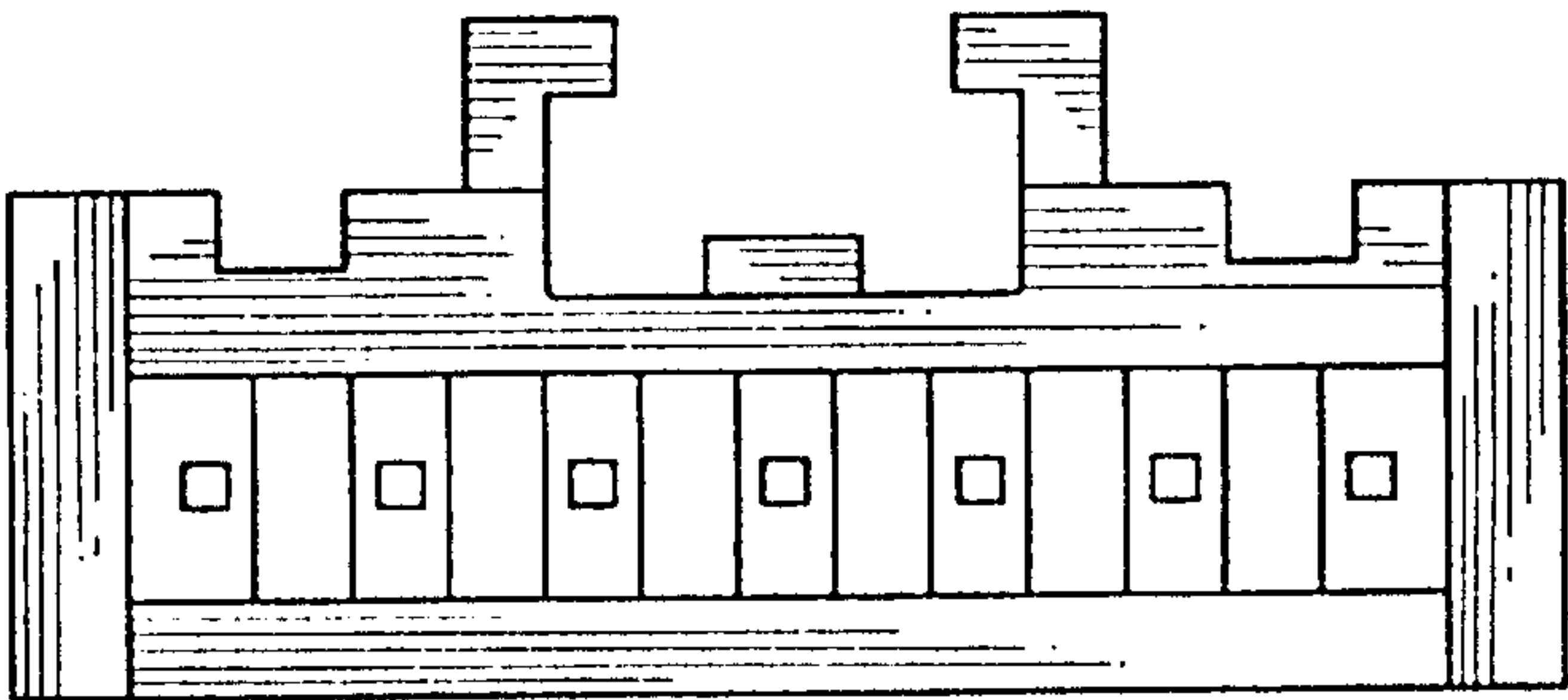


Fig. 4

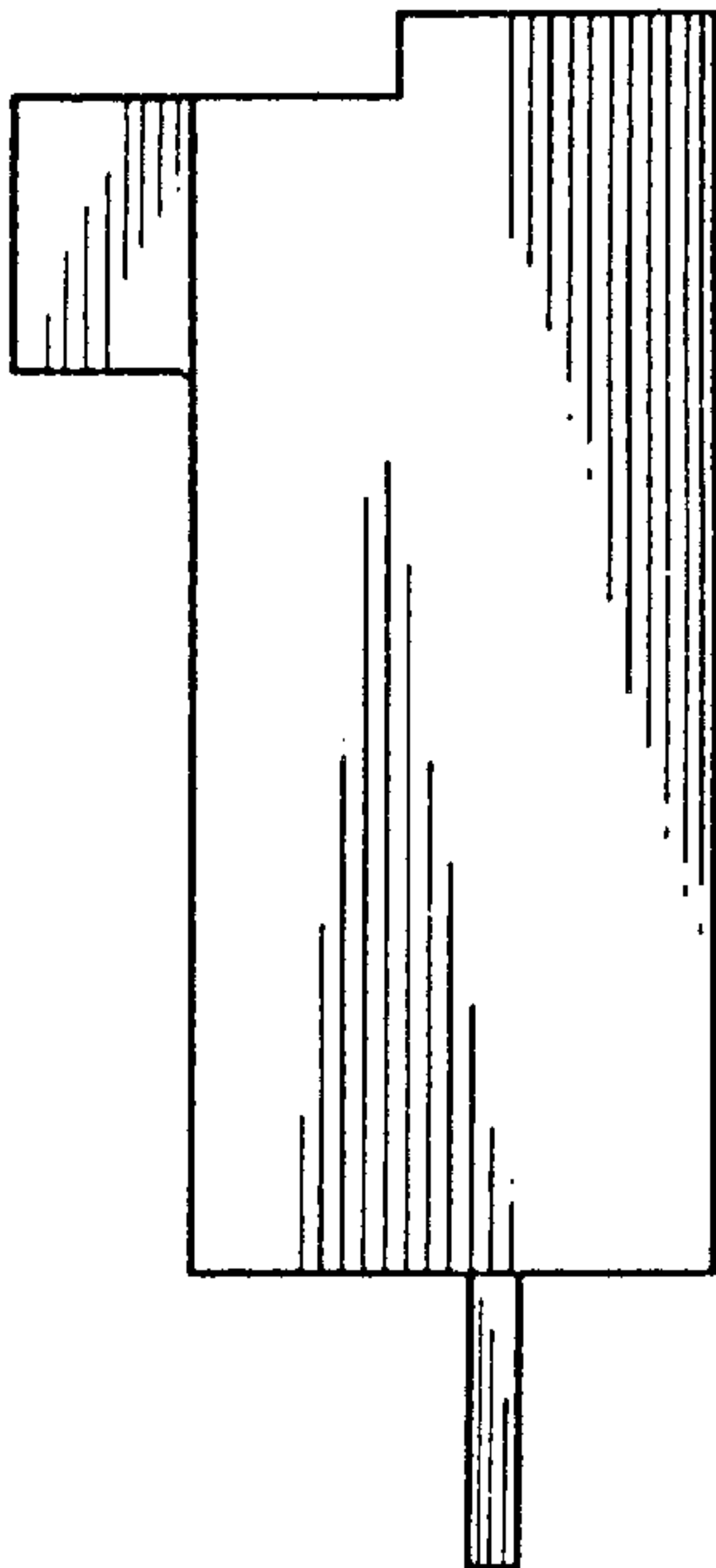


Fig. 5

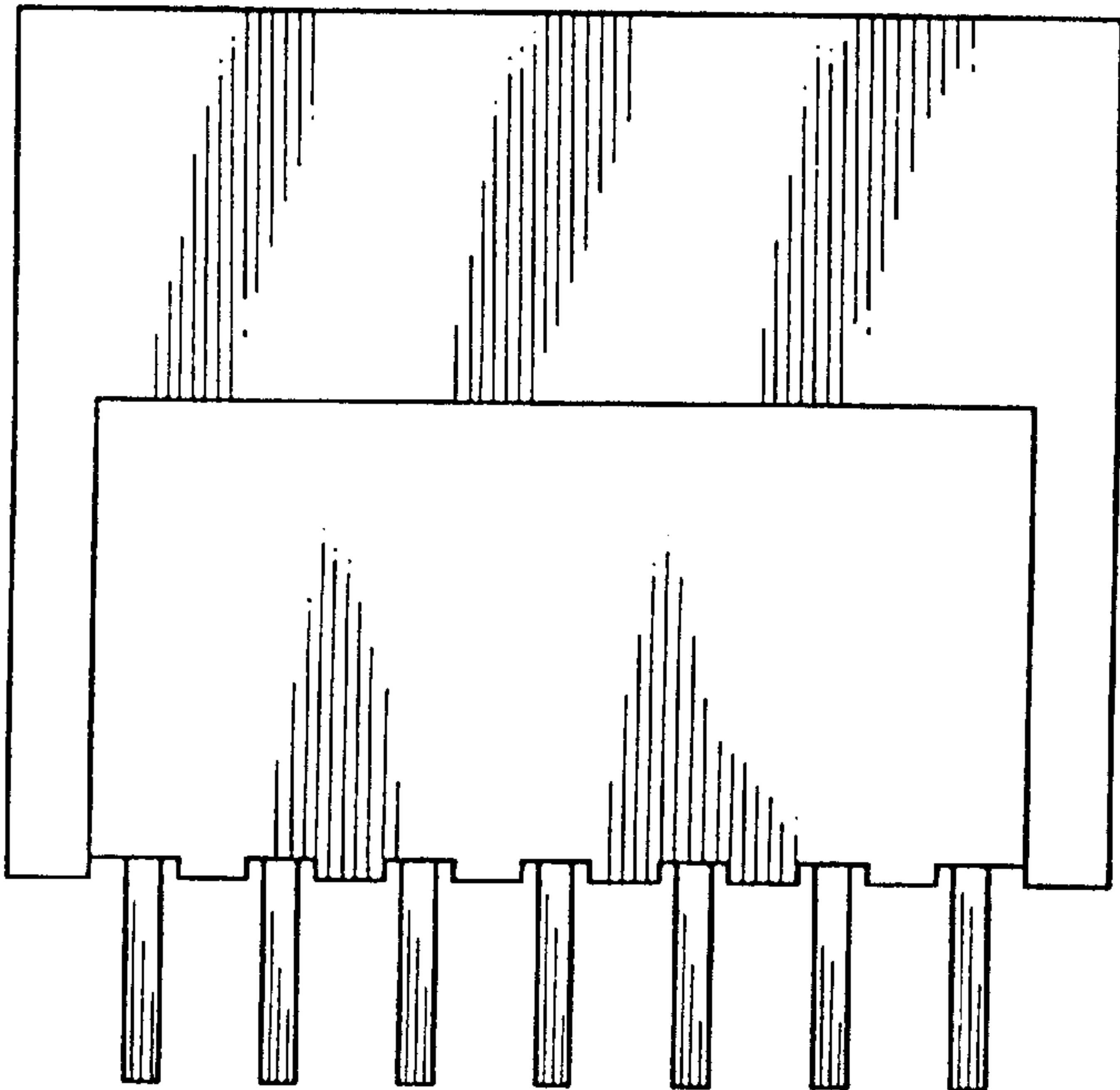


Fig. 6

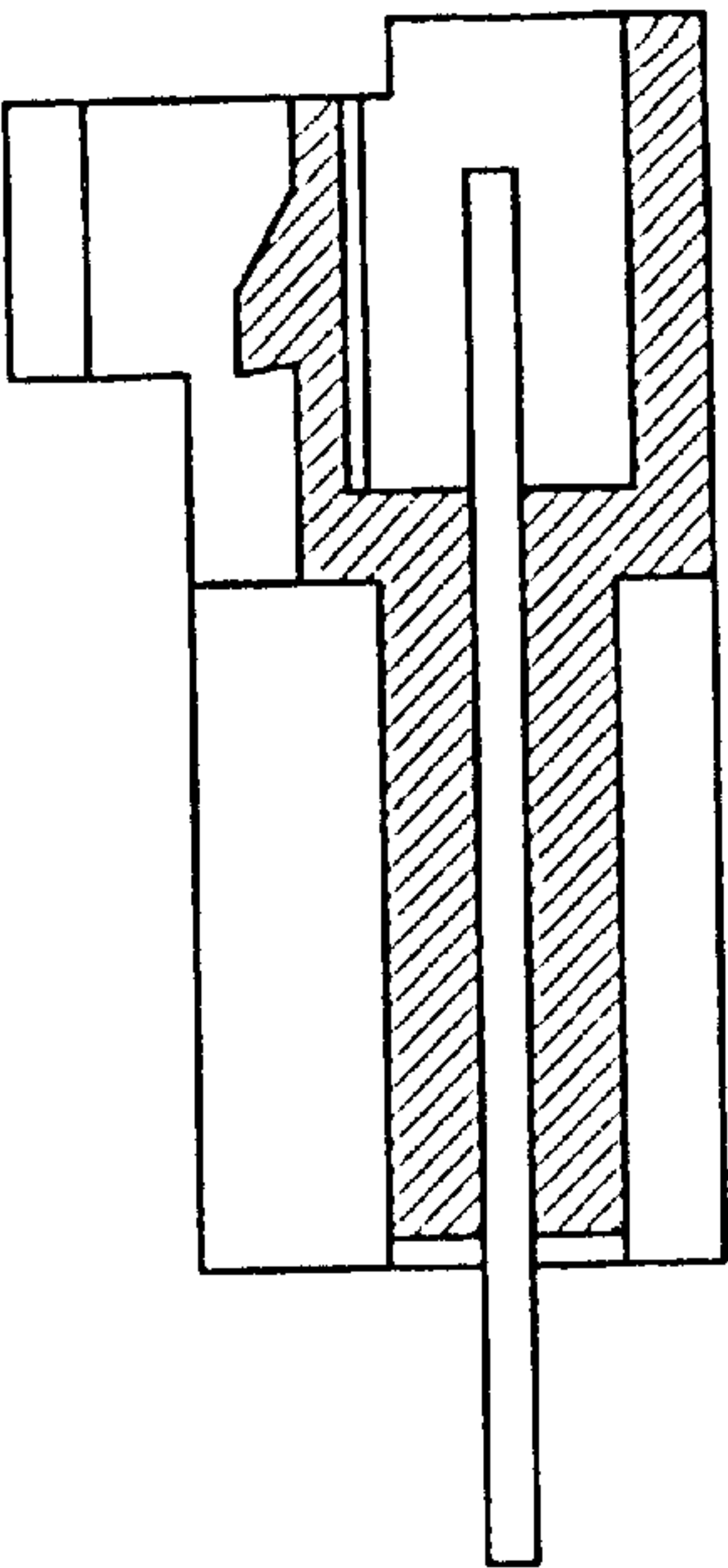


Fig. 7

